TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

# TCR3DM series

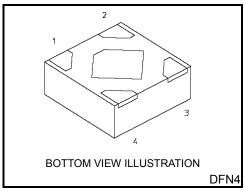
## 300 mA CMOS Low Drop-Out Regulator with inrush current protection circuit

The TCR3DM series are CMOS general-purpose single-output voltage regulators with an on/off control input, featuring low dropout voltage, low output noise voltage and low inrush current.

These voltage regulators are available in fixed output voltages between 1.0 V and 4.5 V and capable of driving up to 300 mA.

They feature over-current protection, over-temperature protection, Inrush current protection circuit and Auto-discharge function.

The TCR3DM series are offered in the ultra small plastic mold package DFN4 (1.0 mm x 1.0 mm; t 0.58 mm). It has a low dropout voltage of 210 mV (2.5 V output,  $I_{OUT}$  = 300 mA) with low output noise voltage of 38  $\mu V_{rms}$  (2.5 V output) and a load transient response of only  $\triangle V_{OUT}$  =  $\pm 80$  mV ( $I_{OUT}$  = 1 mA $\Leftrightarrow$ 300 mA,  $C_{OUT}$  =1.0  $\mu F$ ).



Weight: 1.3 mg (typ.)

As small ceramic input and output capacitors can be used with the

TCR3DM series, these devices are ideal for portable applications that require high-density board assembly such as cellular phones.

#### **Features**

· Low Drop-Out voltage

 $V_{IN}$ - $V_{OUT}$  = 210 mV (typ.) at 2.5 V-output,  $I_{OUT}$  = 300 mA

 $V_{IN}-V_{OUT}$  = 270 mV (typ.) at 1.8 V-output,  $I_{OUT}$  = 300 mA

 $V_{IN}-V_{OUT}$  = 490 mV (typ.) at 1.2 V-output,  $I_{OUT}$  = 300 mA

· Low output noise voltage

 $V_{NO}$  = 38  $\mu V_{rms}$  (typ.) at 2.5 V-output,  $I_{OUT}$  = 10 mA, 10 Hz  $\leq$  f  $\leq$  100 kHz

- Fast load transient response ( $\triangle V_{OUT}$  = ±80 mV (typ.) at  $I_{OUT}$  = 1  $\Leftrightarrow$  300 mA,  $C_{OUT}$  =1.0  $\mu F$  )
- High ripple rejection ( R.R = 70 dB (typ.) at 2.5V-output,  $I_{OUT} = 10 mA$ , f = 1kHz)
- · Over-current protection
- Over-temperature protection
- Inrush current protection circuit
- Auto-discharge function
- · Pull down connection between CONTROL and GND
- Ceramic capacitors can be used ( $C_{IN} = 1.0 \mu F$ ,  $C_{OUT} = 1.0 \mu F$ )
- Ultra small package DFN4 (1.0 mm x 1.0 mm; t 0.58 mm)



## **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit
Input voltage	V <sub>IN</sub>	6.0	V
Control voltage	V <sub>CT</sub>	-0.3 to 6.0	٧
Output voltage	V <sub>OUT</sub>	-0.3 to V <sub>IN</sub> + 0.3	٧
Output current	lout	300	mA
Power dissipation	PD	420 (Note1)	mW
Operation temperature range	T <sub>opr</sub>	−40 to 85	°C
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	−55 to 150	°C

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

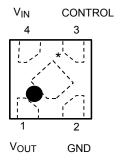
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Rating at mounting on a board

Glass epoxy(FR4) board dimension: 40mm x 40mm x 1.6mm, both sides of board. Metal pattern ratio: a surface approximately 50%, the reverse side approximately 50%

Through hole hall: diameter 0.5mm x 24

## Pin Assignment (top view)



\*Center electrode should be connected to GND or Open

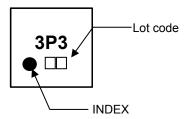
## List of Products Number, Output voltage and Marking

Product No.	Output voltage(V)	Marking	Product No.	Output voltage(V)	Marking
TCR3DM10	1.0	1P0	TCR3DM28	2.8	2P8
TCR3DM105	1.05	1PA	TCR3DM285	2.85	2PD
TCR3DM11	1.1	1P1	TCR3DM30	3.0	3P0
TCR3DM12	1.2	1P2	TCR3DM32	3.2	3P2
TCR3DM13	1.3	1P3	TCR3DM33	3.3	3P3
TCR3DM15	1.5	1P5	TCR3DM36	3.6	3P6
TCR3DM18	1.8	1P8	TCR3DM45	4.5	4P5
TCR3DM25	2.5	2P5			

Please ask your local retailer about the devices with other output voltages.

# **Top Marking (top view)**

Example: TCR3DM33 (3.3 V output)



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## **Electrical Characteristics**

(Unless otherwise specified,  $V_{IN}$  =  $V_{OUT}$  + 1 V,  $I_{OUT}$  = 50 mA,  $C_{IN}$  = 1.0  $\mu$ F,  $C_{OUT}$  = 1.0  $\mu$ F,  $T_j$  = 25°C)

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Output valtage aggurage		50 A (NI-t- O)	V <sub>OUT</sub> <1.8 V	-18	_	+18	mV
Output voltage accuracy	V <sub>OUT</sub>	I <sub>OUT</sub> = 50 mA (Note 2)	1.8V ≦ V <sub>OUT</sub>	-1.0	_	+1.0	%
Input voltage	V <sub>IN</sub>	I <sub>OUT</sub> = 300 mA		1.75	_	5.5	V
Line regulation	Reg·line	$V_{OUT} + 0.5 \text{ V} \le V_{IN} \le 5.5 \text{ V},$ $I_{OUT} = 1 \text{ mA}$		_	1	15	mV
Load regulation	Reg·load	$1 \text{ mA} \le I_{OUT} \le 300 \text{ mA}$		_	18	35	mV
		I <sub>OUT</sub> = 0 mA	V <sub>OUT</sub> = 1.0V	_	65	_	
Out and assument	١,		V <sub>OUT</sub> = 1.8V	_	65	_	- μA
Quiescent current	I <sub>B</sub>		V <sub>OUT</sub> = 2.5V	_	68	_	
			V <sub>OUT</sub> = 4.5V	_	78	125	
Stand-by current	I <sub>B (OFF)</sub>	V <sub>CT</sub> = 0 V		_	0.1	1	μА
Drop-out voltage	V <sub>IN</sub> -V <sub>OUT</sub>	I <sub>OUT</sub> = 300 mA (Note 3)		_	210	290	mV
Temperature coefficient	T <sub>CVO</sub>	-40°C ≤ T <sub>opr</sub> ≤ 85°C		_	75	_	ppm/°C
Output noise voltage	V <sub>NO</sub>	$V_{IN} = V_{OUT} + 1 \text{ V, } I_{OUT} = 10 \text{ mA,} $ 10 Hz $\leq$ f $\leq$ 100 kHz, Ta = 25°C (Note 5)		_	38	_	μV <sub>rms</sub>
Ripple rejection ratio	R.R.	$V_{IN} = V_{OUT} + 1 \text{ V, } I_{OUT} = 10 \text{ mA,}$ f = 1 kHz, $V_{Ripple} = 500 \text{ mV}_{p-p}$ , Ta = 25°C (Note 4)		_	70	_	dB
Load transient response	⊿Vout	I <sub>OUT</sub> = 1⇔300mA, C <sub>OUT</sub> = 1.0 μF		_	±80	_	mV
Control voltage (ON)	V <sub>CT</sub> (ON)	_		1.0	_	5.5	V
Control voltage (OFF)	V <sub>CT</sub> (OFF)	_		0	_	0.4	V

Note 2: Stable state with fixed  $I_{\text{OUT}}$  condition.

Note 3: The 2.5 V output product.

## **Drop-out voltage**

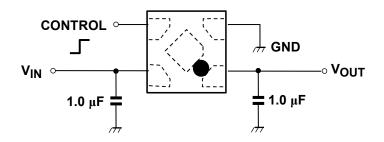
 $(I_{OUT} = 300 \text{ mA}, C_{IN} = 1.0 \mu\text{F}, C_{OUT} = 1.0 \mu\text{F}, T_j = 25^{\circ}\text{C})$ 

Output voltages	Symbol	Min	Тур.	Max	Unit
1.0 V, 1.05 V		_	590	750	
1.1 V			550	650	
1.2 V			490	600	
1.3 V			450	550	
1.4 V		_	390	520	
1.5 V ≤ V <sub>OUT</sub> < 1.8 V			350	450	\ /
1.8 V ≤ V <sub>OUT</sub> < 2.1 V	V <sub>IN</sub> -V <sub>OUT</sub>		270	380	mV
2.1 V ≤ V <sub>OUT</sub> < 2.5 V			240	330	
2.5 V ≤ V <sub>OUT</sub> < 2.8 V			210	290	
2.8 V ≤ V <sub>OUT</sub> < 3.2 V			200	250	
$3.2 \text{ V} \le \text{V}_{OUT} < 3.6 \text{ V}$		_	180	230	
3.6 V ≤ V <sub>OUT</sub> ≤ 4.5 V		-	150	200	

# **Application Note**

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## 1. Recommended Application Circuit



CONTROL voltage	Output voltage
HIGH	ON
LOW	OFF
OPEN	OFF

The figure above shows the recommended configuration for using a Low-Dropout regulator. Insert a capacitor at  $V_{OUT}$  and  $V_{IN}$  pins for stable input/output operation. (Ceramic capacitors can be used).

## 2. Power Dissipation

Board-mounted power dissipation ratings for TCR3DM series are available in the Absolute Maximum Ratings table. Power dissipation is measured on the board condition shown below.

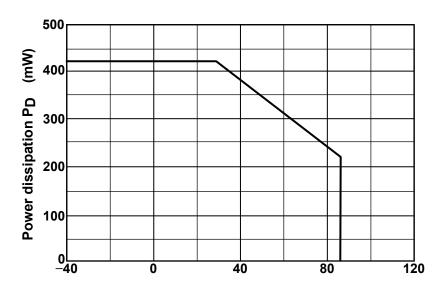
[The Board Condition]

Board material: Glass epoxy(FR4)

Board dimension: 40mm x 40mm (both sides of board), t= 1.6mm

Metal pattern ratio: a surface approximately 50%, the reverse side approximately 50%

Through hole hall: diameter 0.5mm x 24



Ambient temperature Ta (°C)

#### **Attention in Use**

#### Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommend the ESR of ceramic capacitor is under 10  $\Omega$ .

#### Mounting

The long distance between IC and output capacitor might affect phase assurance by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

#### Permissible Loss

Please have enough design patterns for expected maximum permissible loss. And under consideration of surrounding temperature, input voltage, and output current etc, we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 percent.

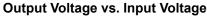
#### Over current Protection and Thermal shut down function

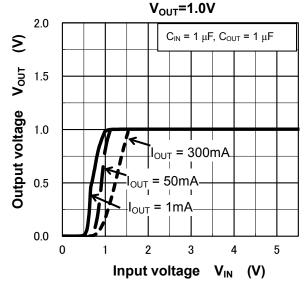
Over current protection and Thermal shut down function are designed in these products, but these are not designed to constantly ensure the suppression of the device within operation limits. Depending on the condition during actual usage, it could affect the electrical characteristic specification and reliability. Also note that if output pins and GND pins are not completely shorted out, these products might be break down.

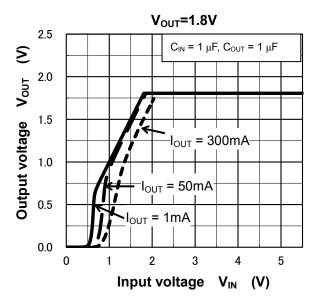
When using these products, please read through and understand the concept of dissipation for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommend inserting failsafe system into the design.

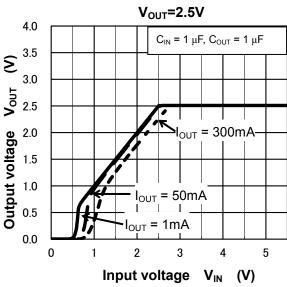
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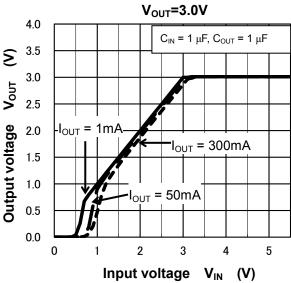
# Representative Typical Characteristics



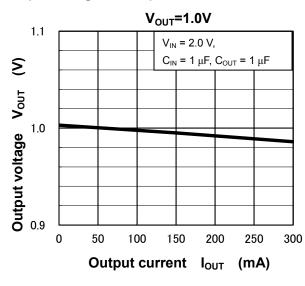


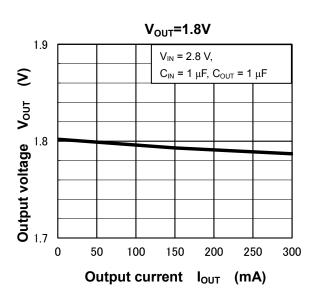


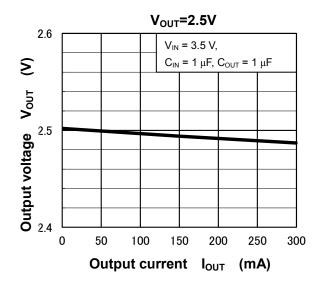


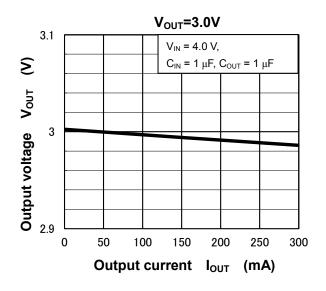


## **Output Voltage vs. Output Current**





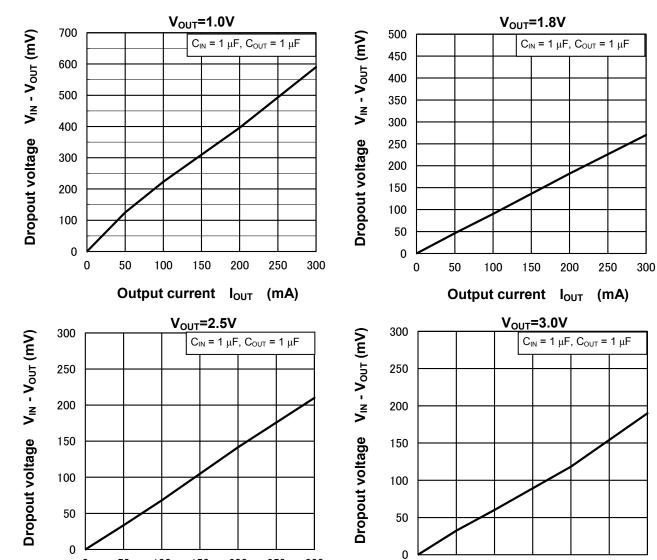




## **Dropout Voltage vs. Output Current**

Output current I<sub>OUT</sub>

(mA)

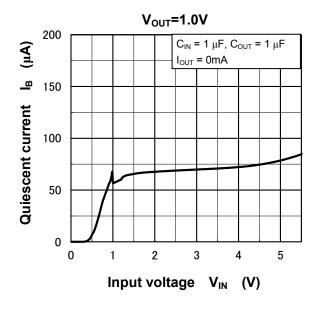


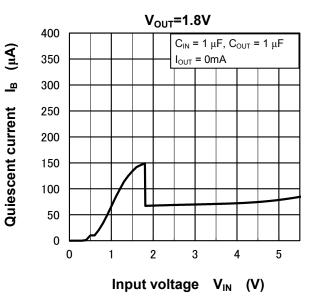
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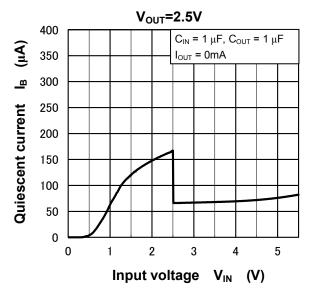
Output current Iout

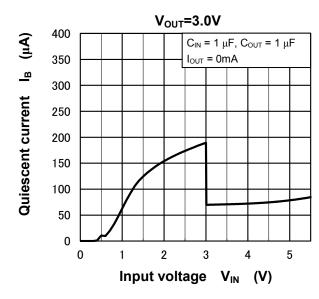
(mA)

## **Quiescent Current vs. Input Voltage**

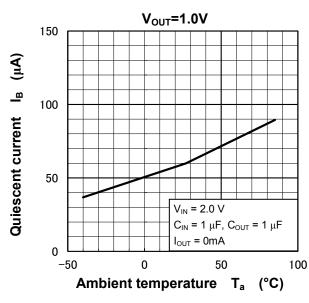


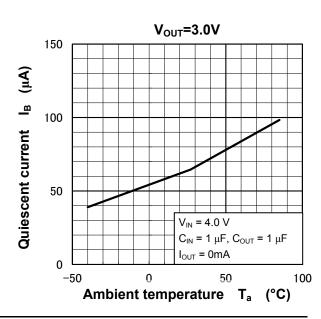






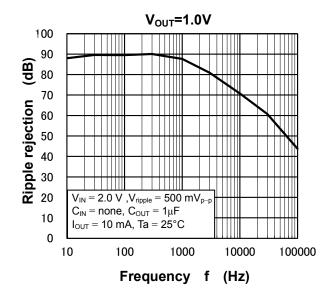
## **Quiescent Current vs. Ambient Temperature**

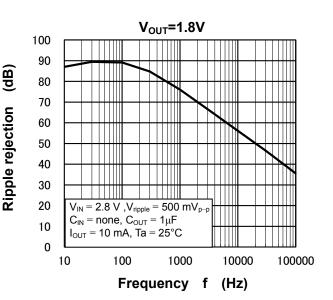


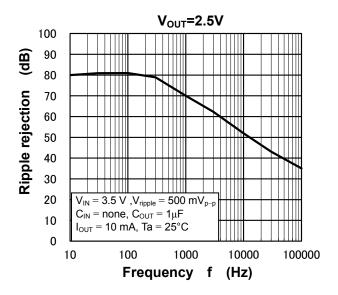


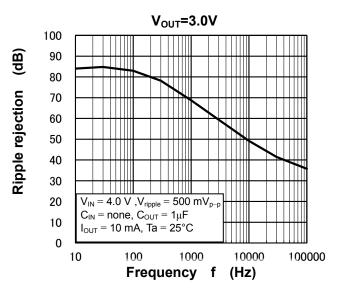
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### Ripple Rejection Ratio vs. Frequency

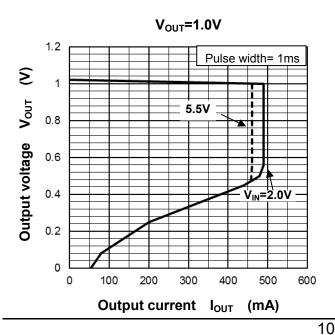


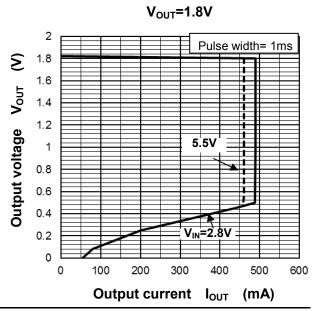


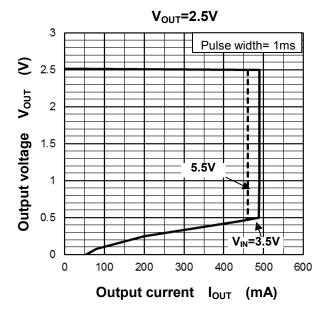


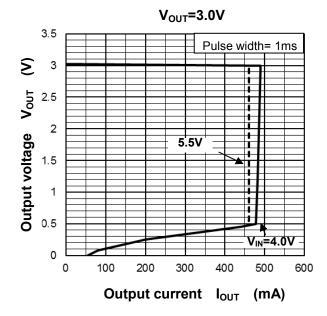


## **Output Voltage vs. Output Current**

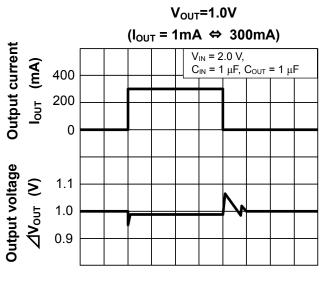


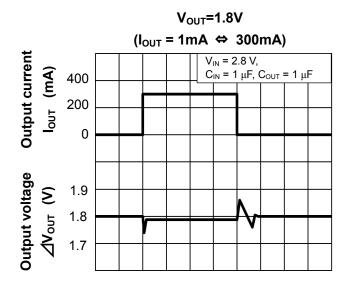




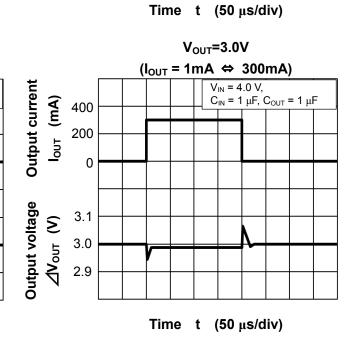


**Load Transient Response** 





Time t (50 μs/div)



V<sub>OUT</sub>=2.5V
(I<sub>OUT</sub> = 1mA ⇔ 300mA)

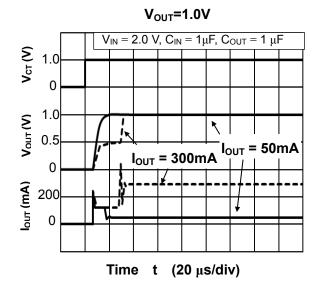
V<sub>IN</sub> = 3.5 V,
C<sub>IN</sub> = 1 μF, C<sub>OUT</sub> = 1 μF

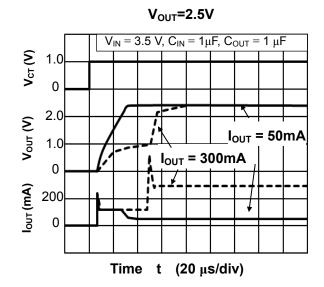
200
0
2.6
2.5
2.4
Time t (50 μs/div)

2014-07-09

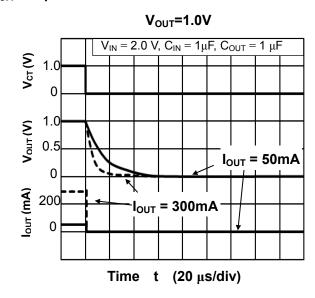


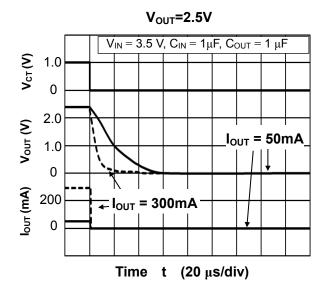
## ton Response





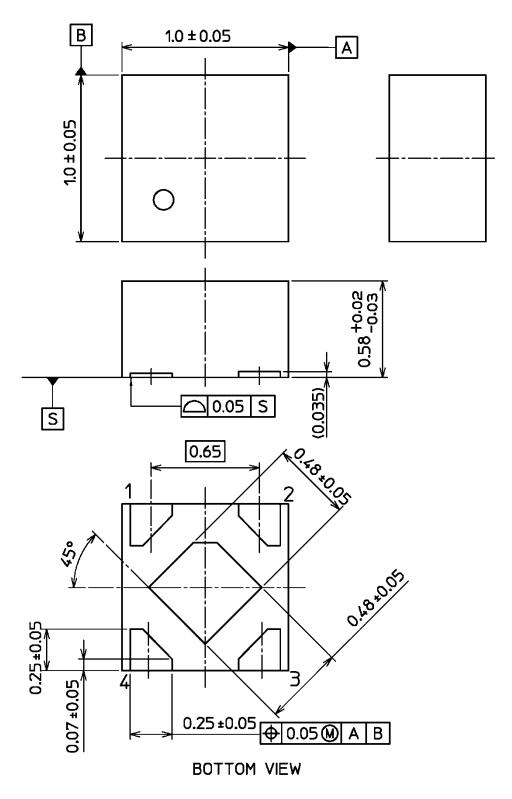
## toff Response





## **Package Dimensions**

DFN4 Unit: mm



0.04 mm (typ.) unevenness exists along the edges of the back electrode to increase shear after soldering.

Weight: 1.3 mg (typ.)

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